

# Dual N-channel MOSFET (common drain)

## ELM18806BA-S

### ■ General description

ELM18806BA-S uses advanced trench technology to provide excellent  $R_{ds(on)}$ , low gate charge and operation with gate voltages as low as 1.8V and internal ESD protection.

### ■ Features

- $V_{ds}=20V$
- $I_d=7A$  ( $V_{gs}=4.5V$ )
- $R_{ds(on)} < 22m\Omega$  ( $V_{gs}=4.5V$ )
- $R_{ds(on)} < 27m\Omega$  ( $V_{gs}=2.5V$ )
- $R_{ds(on)} < 35m\Omega$  ( $V_{gs}=1.8V$ )
- ESD Rating : 2000V HBM

### ■ Maximum absolute ratings

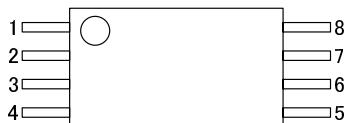
Parameter	Symbol	Limit	Unit	Note
Drain-source voltage	$V_{ds}$	20	V	
Gate-source voltage	$V_{gs}$	$\pm 8$	V	
Continuous drain current	$I_d$	7.0	A	1
		5.7		
Pulsed drain current	$I_{dm}$	30	A	2
Power dissipation	$P_d$	1.5	W	1
		1.0		
Junction and storage temperature range	$T_j, T_{stg}$	-55 to 150	°C	

### ■ Thermal characteristics

Parameter		Symbol	Typ.	Max.	Unit	Note
Maximum junction-to-ambient	$t \leq 10s$	$R_{\theta ja}$	64	83	°C/W	1
Maximum junction-to-ambient	Steady-state		89	120	°C/W	
Maximum junction-to-lead	Steady-state	$R_{\theta jl}$	53	70	°C/W	3

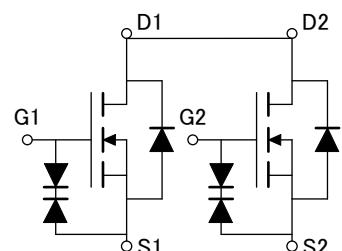
### ■ Pin configuration

TSSOP-8 (TOP VIEW)



Pin No.	Pin name
1	DRAIN1/DRAIN2
2	SOURCE1
3	SOURCE1
4	GATE1
5	GATE2
6	SOURCE2
7	SOURCE2
8	DRAIN1/DRAIN2

### ■ Circuit



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### ■ Electrical characteristics

$T_a=25^\circ C$

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
<b>STATIC PARAMETERS</b>						
Drain-source breakdown voltage	BVdss	$I_d=250\mu A, V_{gs}=0V$	20			V
Zero gate voltage drain current	Idss	Vds=16V			1	$\mu A$
		Vgs=0V	Tj=55°C		5	$\mu A$
Gate-body leakage current	Igss	Vds=0V, Vgs=±4.5V			±1	$\mu A$
		Vds=0V, Vgs=±8V			±10	$\mu A$
Gate threshold voltage	Vgs(th)	Vds=Vgs, Id=250 $\mu A$	0.4	0.6	1.0	V
On state drain current	Id(on)	Vgs=4.5V, Vds=5V	30			A
Static drain-source on-resistance	Rds(on)	Vgs=4.5V		16.5	22.0	$m\Omega$
		Id=7A	Tj=125°C	23.0	29.0	$m\Omega$
		Vgs=2.5V, Id=5.5A		20.0	27.0	$m\Omega$
		Vgs=1.8V, Id=5A		24.0	35.0	$m\Omega$
Forward transconductance	Gfs	Vds=5V, Id=7A		29		S
Diode forward voltage	Vsd	Is=1A, Vgs=0V		0.76	1.00	V
Max. body-diode continuous current	Is				2.5	A
<b>DYNAMIC PARAMETERS</b>						
Input capacitance	Ciss	Vgs=0V, Vds=10V, f=1MHz		1160		pF
Output capacitance	Coss			187		pF
Reverse transfer capacitance	Crss			146		pF
Gate resistance	Rg	Vgs=0V, Vds=0V, f=1MHz		1.5		$\Omega$
<b>SWITCHING PARAMETERS</b>						
Total gate charge	Qg	Vgs=4.5V, Vds=10V, Id=7A		16.0		nC
Gate-source charge	Qgs			0.8		nC
Gate-drain charge	Qgd			3.8		nC
Turn-on delay time	td(on)	Vgs=5V, Vds=10V Rl=1.35 $\Omega$ , Rgen=3 $\Omega$		6.2		ns
Turn-on rise time	tr			12.7		ns
Turn-off delay time	td(off)			51.7		ns
Turn-off fall time	tf			16.0		ns
Body diode reverse recovery time	trr	If=7A, dl/dt=100A/ $\mu s$		17.7		ns
Body diode reverse recovery charge	Qrr	If=7A, dl/dt=100A/ $\mu s$		6.7		nC

### NOTE :

1. The value of  $R\theta_{ja}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board of 2oz. Copper, in still air environment with  $T_a=25^\circ C$ . The value in any given applications depends on the user's specific board design, The current rating is based on the  $t \leq 10s$  thermal resistance rating.
2. Repetitive rating, pulse width limited by junction temperature.
3. The  $R\theta_{ja}$  is the sum of the thermal impedance from junction to lead  $R\theta_{jl}$  and lead to ambient.
4. The static characteristics in Figures 1 to 6 are obtained using 80  $\mu s$  pulses, duty cycle 0.5%max.
5. These tests are performed with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_a=25^\circ C$ . The SOA curve provides a single pulse rating.

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## ■ Typical electrical and thermal characteristics

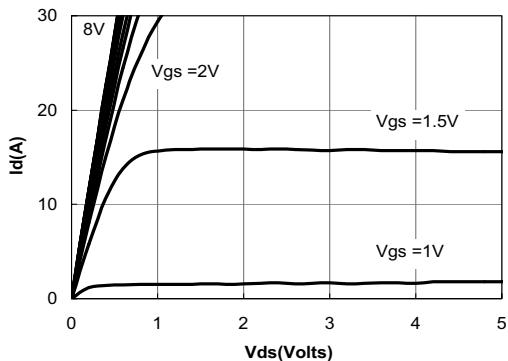


Figure 1: On-Regions Characteristics

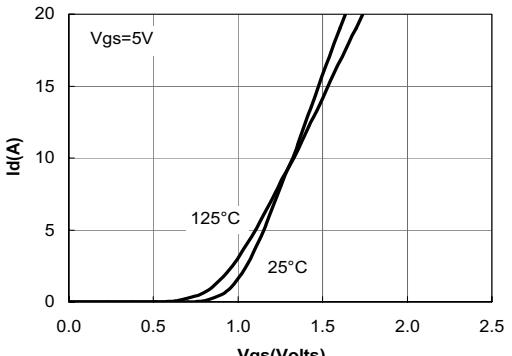


Figure 2: Transfer Characteristics

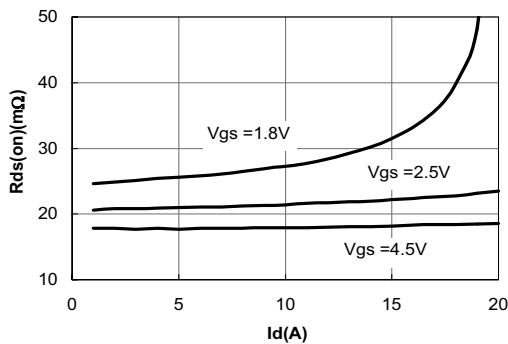


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

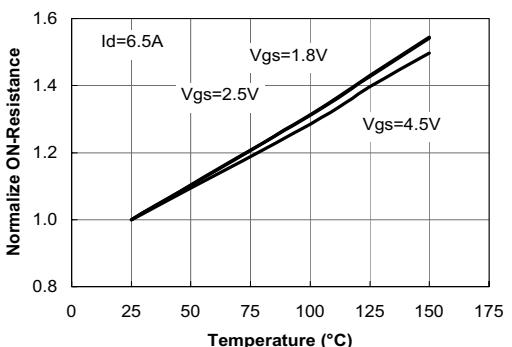


Figure 4: On-Resistance vs. Junction Temperature

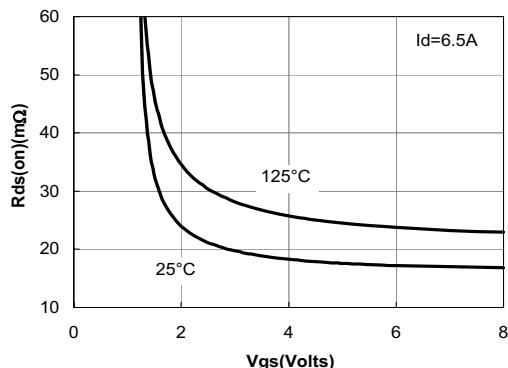


Figure 5: On-Resistance vs. Gate-Source Voltage

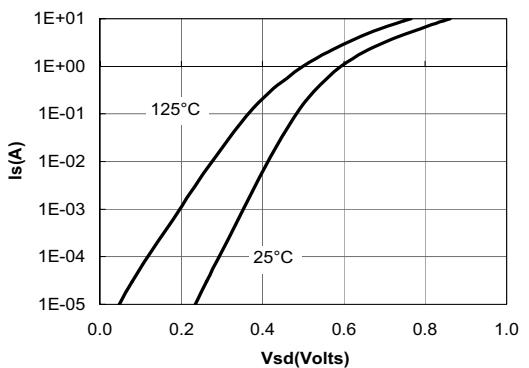


Figure 6: Body-Diode Characteristics

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